Thermal conductance of strongly bonded metal-oxide interfaces

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We report the results of time-domain thermoreflectance (TDTR) measurements of two strongly bonded metal-oxide systems with unusually large thermal conductances. We find that TDTR data for the epitaxial SrRuO3/SrTiO3 interface is consistent with an interface conductance \( G > 0.8 \text{ GW m}^{-2} \text{K}^{-1} \). For an Al/MgO interface at a pressure of 60 GPa, we find \( G \approx 1.1 \text{ GW m}^{-2} \text{K}^{-1} \). Both are within 40% of the maximum possible conductance for these systems, as predicted by simple theory.

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I. INTRODUCTION

Thermal transport properties of bulk crystals are determined by the interplay of three characteristics: translational symmetry, atomic bonding strength, and chemical composition [1]. Near an interface, all three of these characteristics are dramatically altered compared to a bulk material and therefore thermal transport near an interface can be severely impeded [2]. Consequently, the thermal properties of nanostructured materials and nanoscale devices are often dominated by the transport properties of interfaces [3].

Thermal transport across an interface between two crystals is often described with an interfacial thermal conductance \( G \), that relates the heat current at the interface to the temperature drop at the interface, \( J = G \Delta T \). When heat is transported by phonons, the transport coefficient is often assumed to be [4]

\[
G = \frac{1}{4} \sum_j \int t_{\omega} v_{\omega} c_{\omega} d\omega_j. \tag{1}
\]

Here, \( t_{\omega} \), \( v_{\omega} \), and \( c_{\omega} \) are properties for phonons of frequency \( \omega_j \) on one side of the interface where \( j \) labels polarization; \( t_{\omega} \) is the probability of transmission, \( v_{\omega} \) is the group velocity, and \( c_{\omega} \) is the heat capacity per frequency, \( c_{\omega} = \hbar \omega D_{\omega} \partial n_{\omega}/\partial T \), where \( D_{\omega} \) is the density of states and \( n \) is the Bose-Einstein distribution function. According to Eq. (1), the maximum interface conductance an isotropic material can possess with another material \( G_{\text{max}} \) occurs when \( t_{\omega} = 1 \) for all thermally excited vibrational modes and is limited by the rate that thermal energy in the material can impinge on a crystallographic plane. As we have defined it here, \( G_{\text{max}} \) is determined solely by the phonon dispersion relation of a single material and therefore is a material-specific property, not an interface-specific property. The maximum conductance for an interface between two specific materials is restricted by detailed balance to be less than or equal to the value of \( G_{\text{max}} \) that is lowest for the two materials. Values for \( G_{\text{max}} \) are typically on the order of \( 1 \text{ GW m}^{-2} \text{K}^{-1} \) and are linearly correlated with the product of a material’s Debye velocity and volumetric heat capacity, \( v_D C \) (see Fig. 1).

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Observed values of \( G \) range between \( G_{\text{max}}/100 < G < G_{\text{max}}/2 \), because \( t_{\omega} \) is less than unity for a significant fraction of phonon frequencies in most real interfacial systems [3–13]. Factors that cause the average value of \( t_{\omega} \) to be significantly less than unity can be well documented [3,5]. A significant level of interfacial disorder [5–7], interfacial roughness [8], weak interfacial bonding [9,10,13], or drastic differences in the vibrational frequencies of the two constituent materials [11] all result in values of \( G \) that are significantly lower than \( G_{\text{max}} \). Because the vast majority of reported interfacial thermal conductance values are for systems where some, or all, of these four factors are present, it remains unclear whether \( G \) can ever approach or exceed \( G_{\text{max}} \). In other words, the intrinsic limits to \( G \) that result from material properties of the constitutive materials, such as phonon dispersion, are not yet clear because relatively few systems with clean and strongly bonded interfaces have been studied. The highest previously reported values of \( G \) at room temperature are 620 and 700 \text{ MW m}^{-2} \text{K}^{-1} \) for the epitaxial GaN/AlN and TiN/MgO systems [14,15], approximately 40% lower than \( G_{\text{max}} \) for GaN and TiN (Fig. 1). Progress toward a complete microscopic understanding of \( G \) requires additional measurements of systems with clean and strongly bonded interfaces.

Here, we describe the results of two experiments that, in different ways, examine how closely \( G \) can approach \( G_{\text{max}} \). Both experiments focus on systems where the interfacial bonding can be expected to be strong.

In our first set of experiments, we report the results of time-domain thermoreflectance (TDTR) measurements of \( G \) for epitaxial SrRuO3/SrTiO3. Both the SrTiO3 and SrRuO3 possess perovskite crystal structures with alternating layers of SrO and TiO2 (for SrTiO3) and SrO and RuO2 (for SrRuO3) along [001]. Therefore, the SrRuO3/SrTiO3 system has strong interfacial bonds, a commensurate chemical structure, and commensurate bonds on both sides of the interface, with a lattice mismatch of only 0.6% at room temperature [16–18]. Transmission electron microscopy studies demonstrate that pulsed-laser-deposited SrRuO3 thin films can possess coherent and chemically abrupt interfaces with an underlying oxide substrate [19,20]. In short, the SrRuO3/SrTiO3 system possesses close to a model interface.
The electrical resistivity of the SrRuO₃ films varied between 220 and 240 μΩ cm. No correlation between film thickness and electrical resistivity was observed in the thickness range studied herein, indicating boundary scattering is not an important source of resistance in these SrRuO₃/SrTiO₃ samples. Rutherford backscattering confirmed a stoichiometric Sr to Ru ratio of 1.01 ± 0.03.

The thermal transport properties of the SrRuO₃/SrTiO₃ samples were characterized with TDTR using the metallic SrRuO₃ film as an optical transducer [23]. In TDTR, the thermal response of a sample to a train of pump pulses periodically modulated at frequency f is observed by measuring temperature-induced changes in the intensity of a reflected probe beam. Experimental data consists of the in-phase and out-of-phase voltages recorded by a Si photodiode connected to an rf lock-in that picks out the signal components at the pump modulation frequency f. The measured signal is compared to the predictions of a thermal model that uses the thermal properties of the sample as inputs. Unknown thermal properties are adjusted until the predictions of the thermal model agree with the experimental data. In our analysis, the heat capacity and thermal conductivity of SrTiO₃ was fixed to 2.74 J cm⁻³ K⁻¹ based on literature values and 11.5 W m⁻¹ K⁻¹ based on TDTR measurements of Al-coated SrTiO₃ substrates [24,25]. The thermal conductivity of SrRuO₃ was fixed to 5.0 ± 0.5 W m⁻¹ K⁻¹ based on TDTR measurements of an Al-coated 170-nm SrRuO₃ film.

Our standard thermal model for interpreting TDTR data assumes that the laser energy is deposited at the metal film surface and that the intensity fluctuations of the probe beam are proportional to the metal film’s surface temperature [26]. Both of these assumptions are invalid for TDTR measurements that use the thin SrRuO₃ films as the optical transducer because the optical penetration depth of SrRuO₃ is 50 nm at the pump/probe wavelength of 785 nm [23], which is larger than the film thickness. Therefore, we made several changes to our standard thermal model when analyzing the TDTR data collected from bare SrRuO₃/SrTiO₃ samples. First, instead of assuming that the measured signal is proportional to surface temperature of the metal film, we follow Ref. [27] and assume it is proportional to a weighted average of the temperature profile through depths below the surface. The weighting function is calculated from an optical model for the thermoreflectance dR/dT vs film depth using optical constants and thermo-optic coefficients measured via spectroscopic ellipsometry [23]. Second, instead of assuming the heat was deposited at the metal surface, we used a bidirectional model that deposits the heat at a plane on the interior of the metal film some distance z from the surface. A description of how we adapt our thermal model to accommodate bidirectional heat flow from the heated plane can be found in the Appendix of Ref. [28]. We then calculate the thermal response of the sample with z = (n + 1/2)h/10 for n = 0–9, where h is the thickness of the SrRuO₃ film.

Finally, we compare a weighted average of the thermal responses for n = 0–9 to the experimental data, with the spatial derivative of the Poynting vector used as the weighting function.

In our second set of experiments, we report TDTR measurements of G for Al/MgO between 0 and 60 GPa. High-pressure measurements ensure stiff interfaces with strong atomic bonds [21]. Additionally, the reduction in lattice constant and stiffening of elastic constants with increasing pressure [22] allow us to systematically study how G compares to Gmax across a range of vTC values.

The values of G we deduce from TDTR measurements of SrRuO₃/SrTiO₃ and Al/MgO at 60 GPa are the two highest interface conductance values reported to date. Our TDTR measurements of SrRuO₃/SrTiO₃ samples are consistent with G ≥ 0.8 GW m⁻² K⁻¹, approaching our estimates of Gmax ≈ 0.8 and 1.3 GW m⁻² K⁻¹ for SrRuO₃ and SrTiO₃, respectively. For Al/MgO at 60 GPa we find G ≈ 1 GW m⁻² K⁻¹, within 40% of our estimate of Gmax ≈ 1.7 GW m⁻² K⁻¹ for Al at 60 GPa.

II. METHODS

Thin films of SrRuO₃ with thicknesses between 8 and 170 nm were grown from a ceramic SrRuO₃ target via pulsed laser deposition using a KrF excimer laser (LPX 205, Coherent). The SrRuO₃ films were grown on etched and annealed [20] TiO₂-terminated SrTiO₃ (001) substrates from Crystec GmbH, held at 600°C in 100 mTorr of oxygen pressure. X-ray diffraction, x-ray reflectivity, spectroscopic ellipsometry, and four-point probe characterizations were performed on all SrRuO₃ films immediately following growth and immediately prior to the TDTR measurements.
For the measurements of the Al/MgO interface conductance at high pressure, we prepared a clean Al/MgO interface by coating an epi-polished MgO (001) crystal from SPI Supplies with an Al film via dc magnetron sputtering. Prior to the in situ Al deposition, the MgO crystal was heated under high vacuum (\(<5 \times 10^{-8}\) Torr) for 30 min to 1200 K in order to provide as clean an interface as possible. The TDTR measurements were performed in a symmetric piston-cylinder diamond anvil cell with Ar as a pressure medium. Further details of our experimental and thermal modeling methods for performing TDTR measurements in a diamond anvil cell can be found in Refs. [21] and [22].

III. RESULTS

TDTR measurements of thick SrRuO$_3$ films have small sensitivity to $G$ because at film thickness greater than 30 nm, the thermal resistance intrinsic to the SrRuO$_3$ film is larger than the interfacial thermal resistance, $h / \Lambda_{SRO} > G^{-1}$. Unfortunately, for SrRuO$_3$ films less than 30 nm the reflectance of the SrRuO$_3$/SrTiO$_3$ sample is sensitive to the optical constants of SrTiO$_3$. To determine the minimum SrRuO$_3$ film thickness required to prevent the temperature response of the underlying SrTiO$_3$ substrate from affecting the TDTR signal, we performed TDTR measurements on bare SrRuO$_3$/SrTiO$_3$ samples with thicknesses between 8 and 49 nm.

Representative TDTR data for a 16-nm SrRuO$_3$ sample is shown in Fig. 2(a). At pump-probe delay times less than 10 ps, the measured signal is sensitive only to the thermal effusivity of the substrate and the heat capacity per unit area of the metal transducer ($hC$). At pump-probe delay times ranging from 50 ps to 2 ns, the decay rate of the signal is also sensitive to $G$ and the thermal conductivity of the SrRuO$_3$ [see Fig. 2(b)]. In Fig. 3(a), we compare the TDTR-derived value for ($hC$) of seven films between 8 and 49 nm to (1 − $x$)($h_{XRR}C_{SRO}$), where $h_{XRR}$ is the film thickness via x-ray reflection (XRR) measurements, $C_{SRO}$ is the literature value for the heat capacity of SrRuO$_3$ of 2.86 J cm$^{-1}$ K$^{-1}$ [29], and (1 − $x$) is a pinhole correction factor. Atomic force microscopy (AFM) scans of the 9-, 12-, 16-, 23-, 26-, and 28-nm SrRuO$_3$/SrTiO$_3$ samples revealed pinhole surface area coverages of $x = 0.08, 0.03, 0.02, 0.02, 0.003$, and 0.003, respectively, which reduces the heat capacity per unit area of these samples. For film thicknesses larger than 12 nm, TDTR-derived values of ($hC$) are in agreement with (1 − $x$)($h_{XRR}C_{SRO}$). We conclude that for SrRuO$_3$ film thicknesses larger than 12 nm, the thermal response of the SrTiO$_3$ substrate is not an important contributor to the measured signal.

In order to determine $G$ from a TDTR measurement, we fixed ($hC$) to the TDTR-derived value and calculated the mean-square deviation between the prediction of our thermal model and our TDTR data for $G$ between 0.1 and 10 GW m$^{-2}$ K$^{-1}$ [see Fig. 3(b)]. (We do not include the 49-nm film in this figure because the interface conductance is an insignificant thermal resistance in this sample.) In order to account for the fact that the sensitivity decreases with increasing $G$ and increasing $h$, we normalized the maximum sensitivity by the maximum sensitivity of $V_{in}(t)/V_{out}(t)$ to $G$ [see Fig. 3(c)]. For the calculation shown in Figs. 3(b) and 3(c), since we are determining a lower bound for $G$, we fixed the thermal conductivity of the SrRuO$_3$ film to $\Lambda_{SRO} = 5.5$ W m$^{-1}$ K$^{-1}$, the upper limit of our confidence interval. Considering the sensitivity weighted best-fit values of $G$ for the 16-, 23-, 25-, and 28-nm SrRuO$_3$ films, we estimate a lower limit for $G$ of 0.8 GW m$^{-2}$ K$^{-1}$.

Any artifact in the signal caused by SrRuO$_3$ transparency will be most severe for the thinnest films. The best-fit value for $G$ increases with increasing thickness. Therefore, we conclude that any artifacts due to transparency decrease the apparent $G$ and are not the source of the unusually large value of $G$ for SrRuO$_3$/SrTiO$_3$ that we observe.

After performing TDTR measurements of the bare SrRuO$_3$/SrTiO$_3$ samples, we coated the 16- and 28-nm-thick SrRuO$_3$ films with an Al film approximately 80 nm thick and conducted additional TDTR measurements. Both sets of TDTR data for the Al-coated samples are consistent with an interface conductance for Al/SrRuO$_3$ of 0.17 GW m$^{-2}$ K$^{-1}$ ±10%. The addition of the Al/SrRuO$_3$ interfacial conductance to the heat-transfer problem significantly reduces the impact of the SrRuO$_3$/SrTiO$_3$ interface conductance on the decay rate of the sample surface temperature in comparison to measurements of bare SrRuO$_3$ films. For example, the maximum sensitivity of our TDTR data to the SrRuO$_3$/SrTiO$_3$ interface conductance is reduced by a factor of 6 for the 16-nm SrRuO$_3$ sample, from 0.16 to 0.028. Therefore, the addition of the Al film makes our measurements an inferior probe of $G$ for the SrRuO$_3$/SrTiO$_3$ interface. Our thermal model predictions are in agreement with the TDTR measurements of the Al-coated SrRuO$_3$ samples as long as the model input for the SrRuO$_3$/SrTiO$_3$ interface conductance exceeds...
the sensitivity to the interface conductance in a metal/MgO system is high and easily distinguishable from other thermal properties [14]. Figure 4 shows the pressure dependence of \( G \) for the Al/MgO system. For a range of pressure between 0 and 60 GPa, \( \nu vC \) for Al increases by a factor of 2.5 from 8.5 to 22 GW m\(^{-2}\) K\(^{-1}\). Between 0 and 10 GPa, the interface conductance of Al/MgO increases by over 40%, while \( \nu vC \) and \( G_{\text{max}} \) for Al only increase by 30% and 5%, respectively. From 20 to 60 GPa, \( G \) of Al/MgO increases by \( \approx 25\% \), while \( \nu vC \) and \( G_{\text{max}} \) increase by 35% and 20%, respectively. That \( G \) increases much more rapidly with pressure than \( G_{\text{max}} \) below 10 GPa suggests that the average transmission coefficient \( t_0 \) is increasing due to an increase in interfacial bonding strength and stiffness [21]. This result is mildly surprising since the MgO was heated to 1200 K under high vacuum immediately prior to Al deposition in order to remove surface contamination, suggesting that interfacial stiffness is an influential parameter for interfacial conductance, even when the interface is relatively clean.

### IV. Analysis and Discussion

To estimate \( G_{\text{max}} \) using Eq. (1), we approximated the group velocity of the acoustic phonons as

\[
\frac{\partial \omega}{\partial q} = v_j - 2 \left( \frac{\nu_j q D - \omega_M}{q D^2} \right) q,
\]

where \( j \) labels either the longitudinal or transverse phonon branches, \( q \) is the wave vector, \( q D = (6\pi^2 n)^{1/3} \), where \( n \) is the volumetric unit-cell density, and \( \omega_M \) is the maximum frequency for a wave vector in the [100]. Equation (2) yields a dispersion relation that is a second-order polynomial that converges to \( \omega_M \) near the zone boundary. For the optic

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FIG. 3. (Color online) (a) Comparison of the TDTR-derived value for the heat capacity of the SrRuO\(_3\) film per unit area (\( hC \)) to the value derived from x-ray reflectivity measurements of film thickness. At thicknesses above 12 nm the two measures of the film heat capacity per unit area are in agreement, indicating the TDTR measurement is robust despite the fact that the SrRuO\(_3\) films are not optically opaque. (b) Mean-square deviation between the predictions of the thermal model and the TDTR data as a function of \( G \). (c) Normalized mean-square deviation between thermal model predictions and TDTR data. Each point on each mean-square deviation curve is normalized by the TDTR signal’s maximum sensitivity to \( G \) for that \( x \)-axis value of \( G \). The curves were normalized in this way to account for the decreasing measurement sensitivity to \( G \) with increasing \( G \). The dashed vertical line at 0.8 GW m\(^{-2}\) K\(^{-1}\) represents our estimate of the lower bound conductance that is consistent with our TDTR measurements.

FIG. 4. Pressure dependence of the thermal conductance of an Al/MgO interface. The top axis shows how the product of Debye velocity and heat capacity of Al increases with pressure. At pressures less than 10 GPa, \( G \) increases with pressure more rapidly than our prediction for \( G_{\text{max}} \) of Al, suggesting an increase in the average phonon transmission coefficient due to the stiffening of interfacial bonding with pressure. Above 10 GPa, \( G \) increases at approximately the same rate as our prediction for \( G_{\text{max}} \). At 60 GPa, the conductance of Al/MgO is within 40% of the maximum predicted by Eq. (1).
phonons, we assume a linear dispersion relation and calculate the group velocity via a best fit to the neutron-scattering measurements of the dispersion relation in high-symmetry directions. Table I provides the material properties used to calculate the values of $G_{\text{max}}$ shown in Fig. 1.

To test how accurate of an approximation Eq. (2) is for cubic crystals, we calculated $G_{\text{max}}$ for Al and Au with several other dispersion relations. Using a Born–von Karman force constant model [30,31] to calculate the phonon frequencies and group velocities across the entire Brillouin-zone results in $G_{\text{max}}$ for Al and Au of 1.3 and 0.6 GW m$^{-2}$ K$^{-1}$, in good agreement with the values of 1.3 and 0.5 GW m$^{-2}$ K$^{-1}$ we derived using Eq. (2). For comparison, a Debye approximation for the dispersion relation yields 2.1 and 1.1 GW m$^{-2}$ K$^{-1}$ for $G_{\text{max}}$ of Al and Au, a truncated Debye model of the type used in Ref. [32] yields 0.8 and 0.3 GW m$^{-2}$ K$^{-1}$ for $G_{\text{max}}$ of Al and Au, and a sine-type dispersion of the type used in Ref. [33] yields 0.8 and 0.4 GW m$^{-2}$ K$^{-1}$ for $G_{\text{max}}$ of Al and Au. Finally, using separate sine-type dispersion approximation for the longitudinal and transverse branches yields 0.9 and 0.5 GW m$^{-2}$ K$^{-1}$ for $G_{\text{max}}$ of Al and Au. We conclude that Eq. (2) is an accurate approximation for the dispersion relation of acoustic phonons in cubic materials.

Our calculation of $G_{\text{max}}$ includes all optic phonon branches. The value derived for $G_{\text{max}}$ is insensitive to whether we approximate the experimental dispersion relations of optic branches with linear curves, higher-order polynomials, or numerically interpolated curves. However, for the SrTiO$_3$ optic phonons, the isotropic assumption appears to be less robust than for acoustic phonons. For SrTiO$_3$, assuming isotropic dispersion relations for the optic phonons that replicate the dispersion curves in exclusively the [100], [110], or [111] yields $G_{\text{max}}$ values of 1.1, 1.1, or 1.6 GW m$^{-2}$ K$^{-1}$, respectively. The linear approximation for the optic branches of SrTiO$_3$ provided in Table I describes dispersion curves that split the differences between these three directions, therefore yielding a $G_{\text{max}}$ of 1.3 GW m$^{-2}$ K$^{-1}$.

Experimental data for the phonon dispersion relation of SrRuO$_3$ are not available, precluding us from confidently estimating $G_{\text{max}}$ for SrRuO$_3$. Given that the ratio of $v_\parallel$C for SrRuO$_3$ to $v_\perp$C for SrTiO$_3$ is 0.6, a crude estimate for $G_{\text{max}}$ of SrRuO$_3$ is 0.8 GW m$^{-2}$ K$^{-1}$, corresponding to 0.6 of $G_{\text{max}}$ for SrTiO$_3$. Alternatively, assuming the phonon dispersion relation of SrRuO$_3$ at room temperature is well approximated by the [100] and [010] dispersion relations of SrRuO$_3$ in its ferromagnetic ground state, as calculated by Miao et al. via first principles [34], yields a $G_{\text{max}}$ value of 0.7 GW m$^{-2}$ K$^{-1}$.

In the present work, we have limited our analysis to systems where the interfacial bonding can be expected to be reasonably strong because both theoretical and experimental studies have demonstrated that weak interfacial bonding can severely impede interfacial heat flow [9,10,21,35–37]. In other words, weak interfacial bonding significantly lowers the probability that phonons that impinge on an interface will transmit to the other side, thereby resulting in a value for $G$ that is determined by the microscopic details of the interface and not the two constituent materials. Alternatively, several theoretical studies have predicted that the transmission probability can be reduced by a small amount if the stiffness of interfacial bonds is made larger than the stiffness of the bonds of the two constituent materials [35,36]. To our knowledge, a reduction in $G$ due to overly stiff interfacial bonds has not been experimentally observed.

Despite large values of $G$ for SrRuO$_3$/SrTiO$_3$ and (Al/MgO)$_{\text{10}}$GPa that are near $G_{\text{max}}$, we cannot conclude that the average interfacial transmission coefficient $t_\text{a}$ approaches unity for the majority of heat-carrying phonons because the derivation of Eq. (1) approximates the phonon occupation of all phonons with an equilibrium phonon distribution on both sides of the interface [38,39]. Equation (1) is only an accurate description of thermal transport across an interface at position $z$ if $T(z - \ell_\omega) - T(z + \ell_\omega) \approx \Delta T$, where $\Delta T$ is the temperature drop at the interface and $\ell_\omega$ is the average mean-free path of a phonon of frequency $\omega$ [40]. In other words, $G_{\text{max}} \Delta T$ is not the largest possible heat current at the interface if a significant fraction of heat-carrying phonons ballistically traverse a significant temperature drop in the material prior to transmitting across the interface. The approximation $T(z - \ell_\omega) - T(z + \ell_\omega) \approx \Delta T$ is valid if $\ell_\omega \ll L_K$, where the Kapitza length $L_K = \Lambda/G$ is the distance across which the temperature drop in the material will equal the temperature drop at the interface. For large values of $G$, i.e., $G \approx 1$ GW m$^{-2}$ K$^{-1}$, $\ell_\omega \ll L_K$ is likely unsatisfied for a significant fraction of

<table>
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<th>Property</th>
<th>Au</th>
<th>Ge</th>
<th>Al</th>
<th>Si</th>
<th>NiSi$_2$</th>
<th>GaN</th>
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$^a$Reference [43]; $^b$Reference [44]; $^c$Reference [45]; $^d$Reference [46]; $^e$Reference [47]; $^f$Reference [48]; $^g$Reference [49]; $^h$Reference [50]; $^i$Reference [51]; $^j$Reference [52]; $^k$Reference [53]; $^l$Reference [30]; $^m$Reference [54]; $^n$Reference [55]; $^o$Reference [56]; $^p$Reference [57]; $^q$Reference [58]; $^r$Reference [59].
heat-carrying phonons, meaning $J_\omega$ may exceed $t_{\omega}v_\omega c_\omega \Delta T/4$ for a significant fraction of phonon frequencies.

In conclusion, identifying the limits to the interface conductance that are intrinsic to the constituent materials, and not intrinsic to properties of the interface, is an important step towards a complete microscopic understanding of interfacial thermal transport. We have defined a simple material property $G_{\text{max}}$ that is a useful tool for estimating the interface conductance of strongly bonded systems (see Fig. 1). In general, the TDTR measured conductances of the clean interfaces compiled in Fig. 1 lie in a relatively narrow range, $0.3G_{\text{max}} < G < 0.7G_{\text{max}}$. (Au is an exception, likely due to electron-phonon resistance near the interface [28,41].) We characterized the thermal conductance of two strongly bonded interfaces, SrRuO$_3$/SrTiO$_3$ at ambient pressure and Al/MgO at high pressure. Both interfaces have unusually high thermal conductances.

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